

Semiconducting Materials and applications

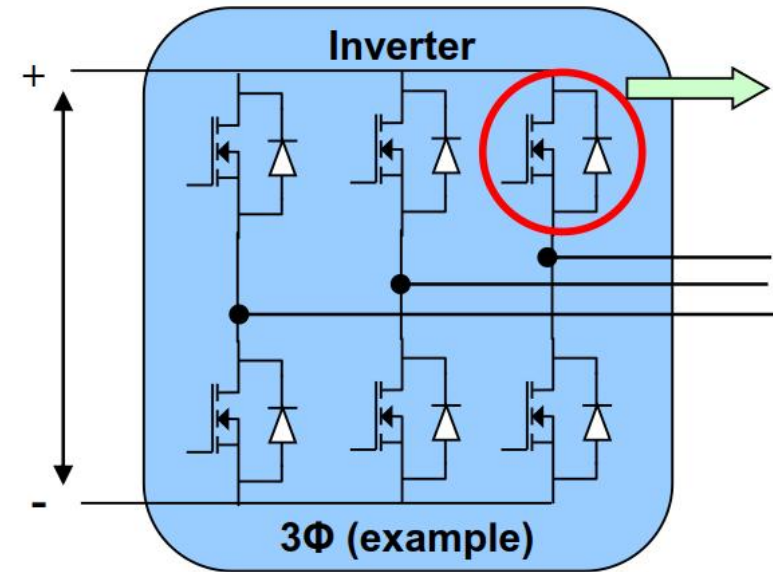
Learning outcome

At the end of this lecture you will be able to:

- List different applications of semiconductor materials
- Explain the physics behind semiconductor material
- Understand how the semiconductors are manufactured
- Explain the operation of semiconductor diode
- Explain the operation of semiconductor transistor

Semiconductor applications

- Diodes and transistors
 - Low and high power
 - Electronics
 - Power electronics
 - Computer chips
- Detectors and Solar cells
 - Light and particle detection
 - Electric energy generation (PV)
- Optoelectronics
- LEDs and Lasers
 - Efficient lighting
 - Instrumentation and medical applications



Courtesy of Mark Johnson, Department of Materials Science & Engineering, NC State University



Materials bonding

- Atoms bond to each other to form material structures. Different bond are responsible for different properties
- **Ionic bond:** electron transferred from atom to the other
 - Hard and brittle, non conducting e.g. NaCl, CsCl, and ZnS
- **Covalent bond:** valence electrons shared between atoms
 - Very hard, non conducting e.g. Diamond, Silicon, Graphite
- **Metallic bond:** like covalence bond but **electrons are delocalized**
 - Varying hardness, conducting e.g. Iron, silver, Copper
- **Hydrogen bond:** **electrostatic attraction** between atoms or molecules
 - Had and brittle, non conducting e.g. Ice and organic solids
- **Van der Waals bond:** interaction due to **charge shift** within atoms or molecules
 - Weak interaction, soft and brittle, non conducting e.g. Noble gas (Ar, Ne, Xe)

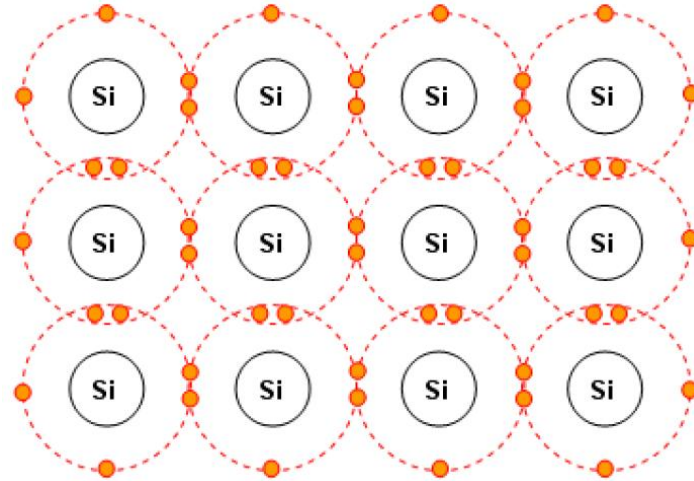
Semiconductor

- Semiconductor materials have **two kind of charge carriers**
 - **Doping** the materials (impurities) increases the concentration of one or the other
 - Negative carriers = electrons. **n-type semiconductor**
 - Positive carriers = holes. **p-type semiconductor**
- Most semiconductors are **Si-based**
 - **Easy and established** processing methods
 - **Cheap and abundant** material (4" wafer of Si @30€ vs. 2" wafer of InP @300€)
- **High speed** electronics, up to **600 GHz** requires GaAs, InP, or SiGe
- **High voltage** applications require GaN or SiC

SiC = Silicon Carbide
GaAs = Gallium Arsenide
GaN = Gallium Nitride
InP = Indium Phosphide

Semiconductors

- Si has 4 valence electrons and 4 are missing from the outer shell
 - Most **electrons have low mobility** and thus do not participate in the conduction
 - Pure Si is a poor conductor

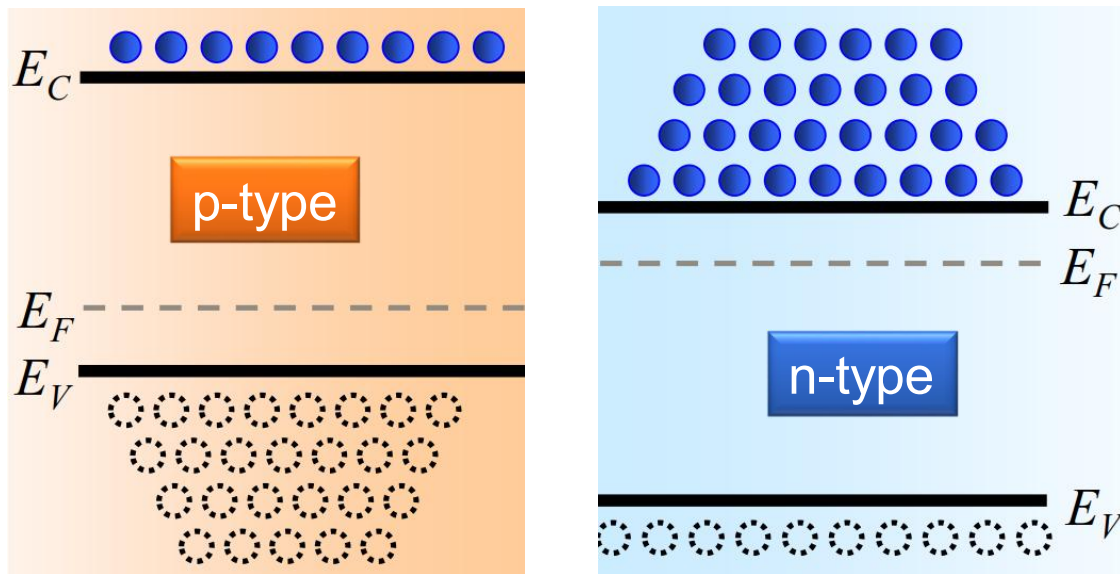


Figures: Courtesy of Prof. Hele Savin

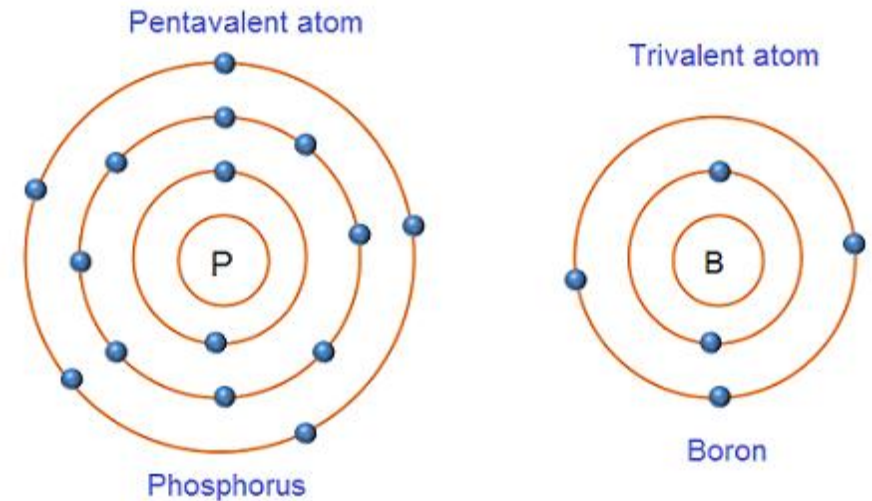
- In normal temperature, some **electrons jump** from the valence band to the conducting band **leaving a hole**
 - A hole can also be a current carrier just as the electron
 - Note that there is an **energy bandgap** between the two states
 - In intrinsic semiconductors (Si, Ge) the concentration of electrons and holes is the same

Semiconductors

- Intrinsic semiconductors like Si can be doped
 - the concentration of holes or electrons is higher p and n-type
- Pentavalent impurities: Phosphorus (P), Arsenic (As), Antimony (Sb)
- Trivalent impurities: Boron (B), Gallium (G), Indium(In), Aluminium(Al)

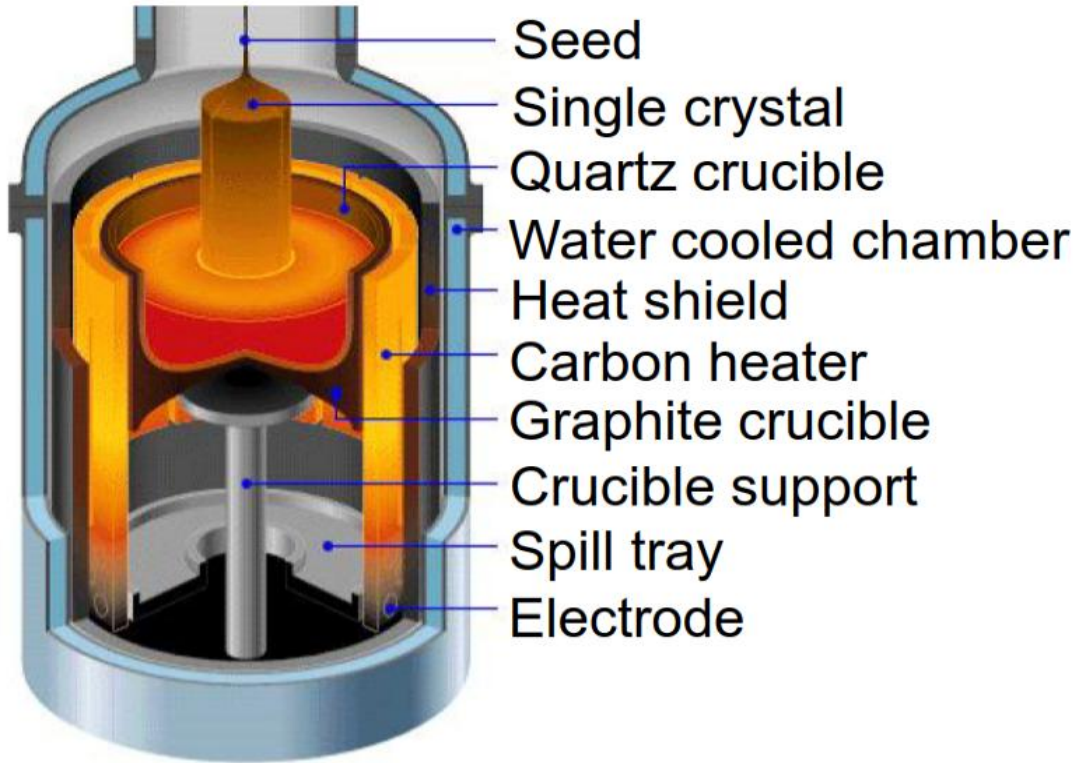


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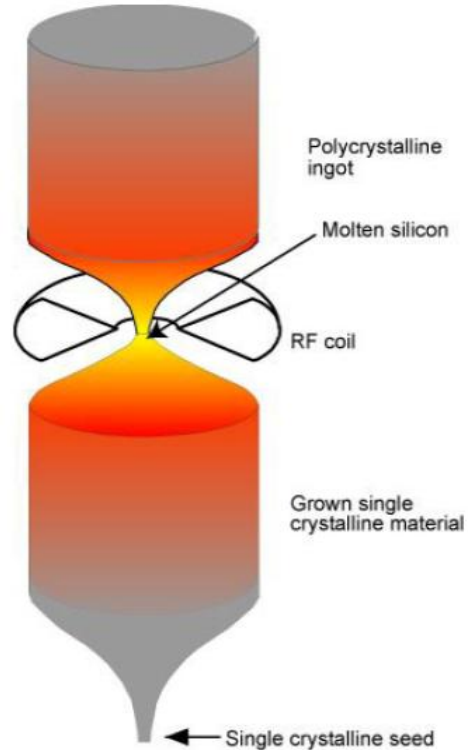


Manufacturing of Semiconductors

Growing a silicon ingot can take from one week to one month

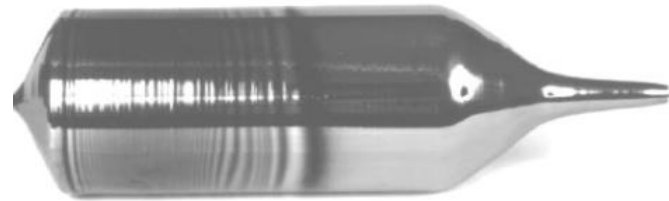
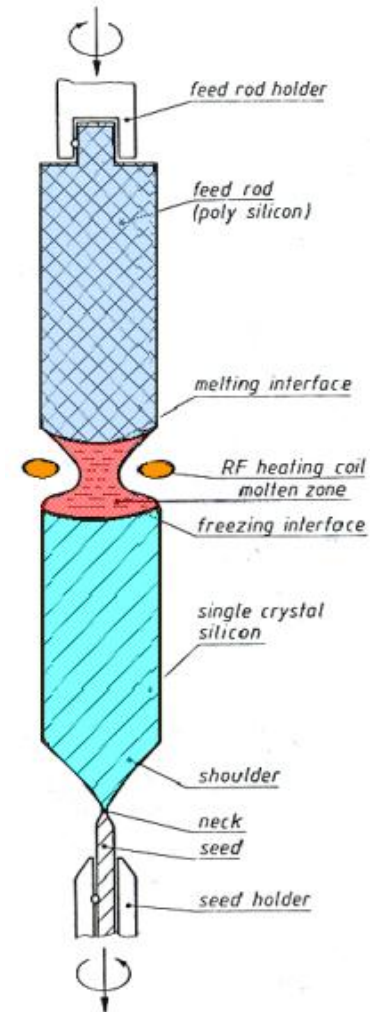


Crystal pulling method



Float-zone method

Float-zone pulling

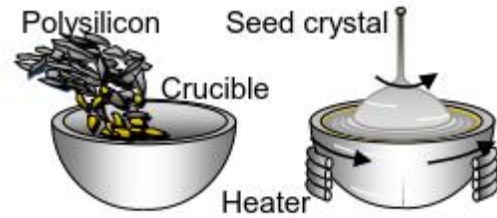


Manufacturing of silicon wafer

Boron: P type

Phosphorus, Antimony, Arsenic: N type

1. Crystal Growth



2. Single Crystal Ingot



3. Crystal Trimming and Diameter Grind



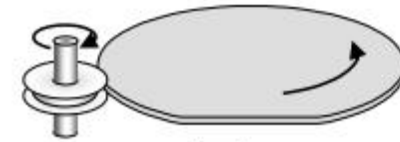
4. Flat Grinding



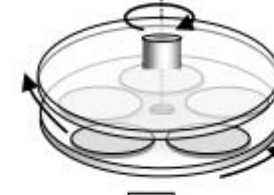
5. Wafer Slicing



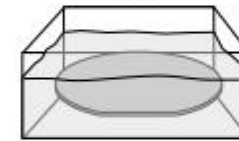
6. Edge Rounding



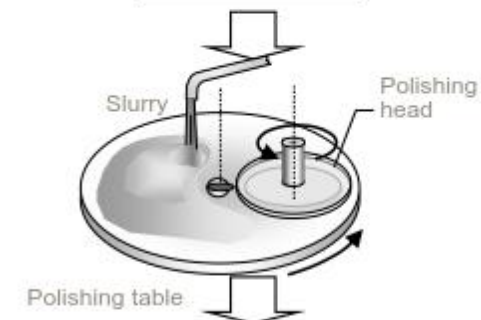
7. Lapping



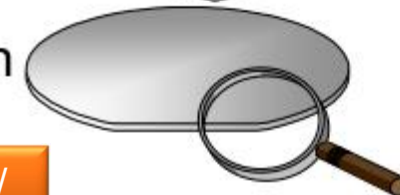
8. Wafer Etching



9. Polishing

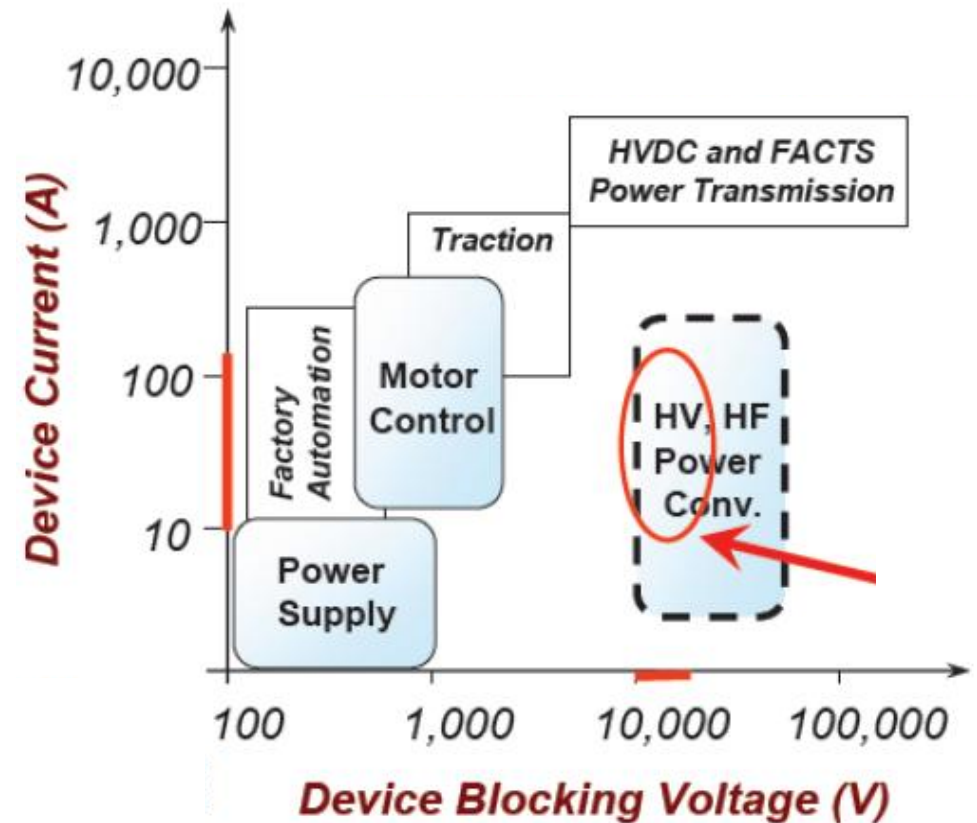


10. Wafer Inspection



Semiconductor applications

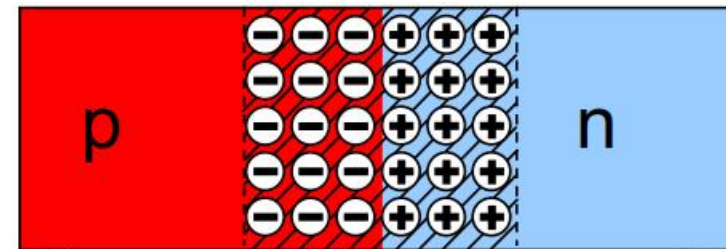
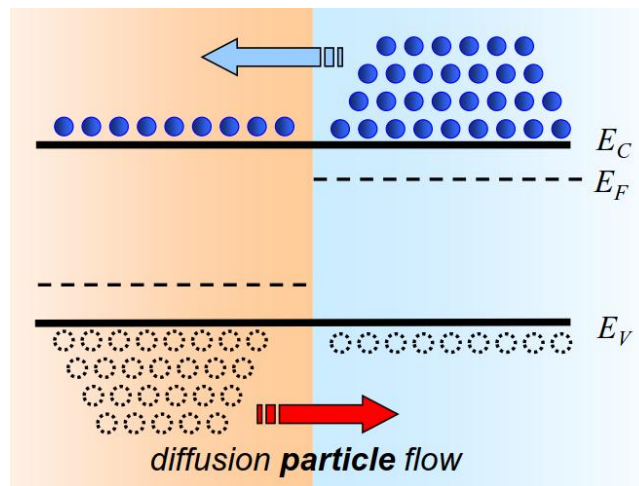
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n-p Junction and diode

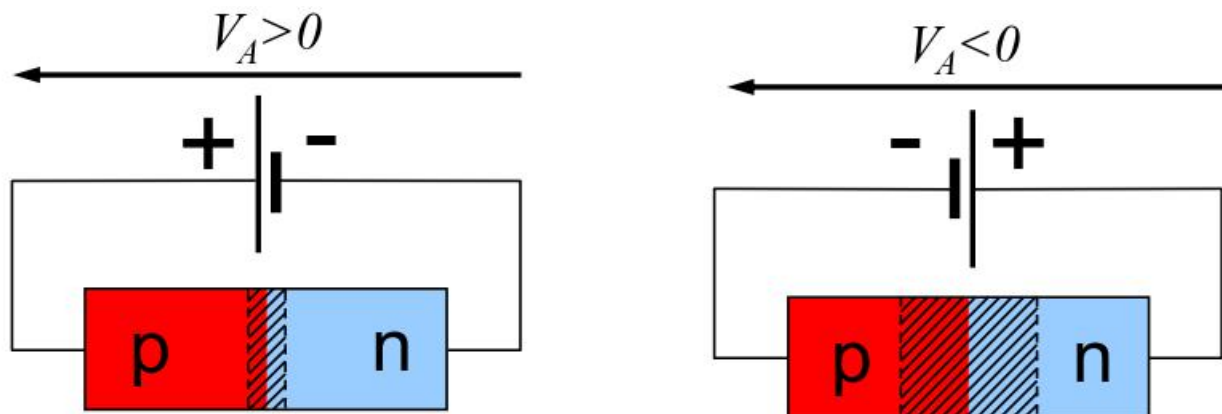
- n-p junction diodes are made by putting side-by-side n- and p-type semiconductors
- Diffusion phenomena occurs in the conduction and valence bands
 - In conduction band, electrons diffuse from n- to p-region
 - In valence band, holes diffuse from p- to n-region
- Diffusion is limited by the remaining charges creating an electric field
 - A region of recombined holes-electrons is formed: depletion Region



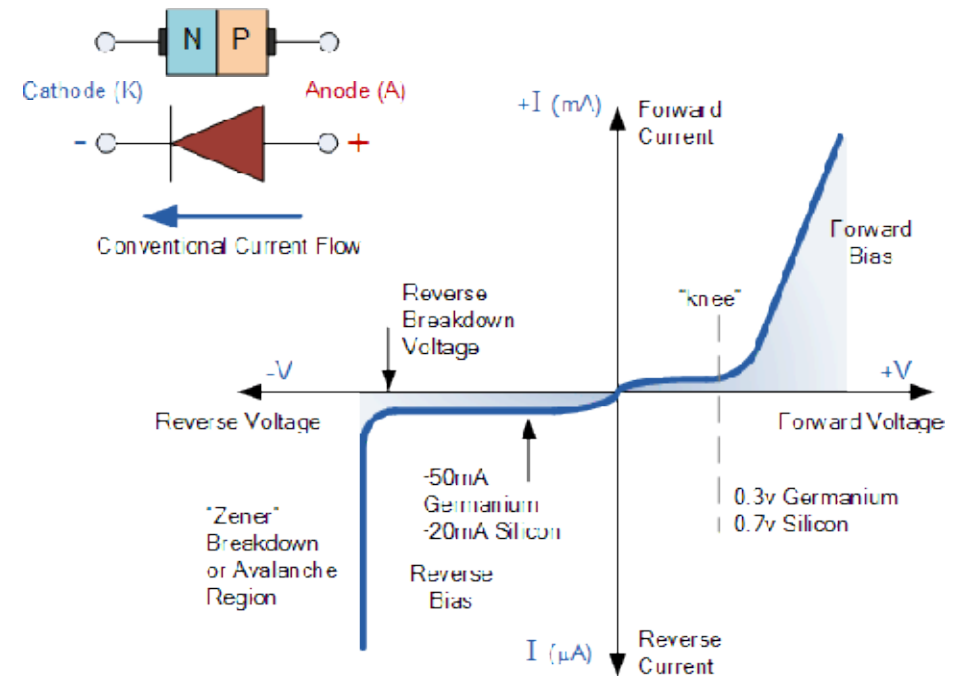
Figures: Courtesy of Prof. Hele Savin

n-p Junction and diode

- Depletion region forms an equivalent of an **insulation layer**
- **Positive voltage** applied over the p-n junction
 - The depletion region get thinner and a current start flowing → **forward conduction**
- **Negative voltage** applied over p-n junction
 - The depletion region get wider and thus no current can flow → **reverse blocking**
- **Excessive negative voltage** over p-n junction
 - **Breakdown** of the insulation layer and current flow

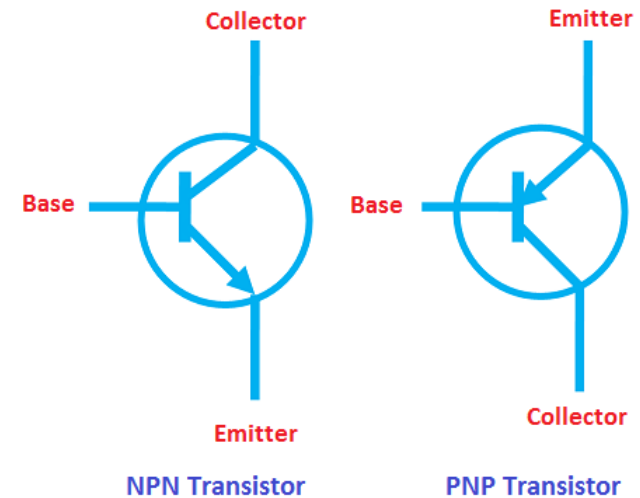
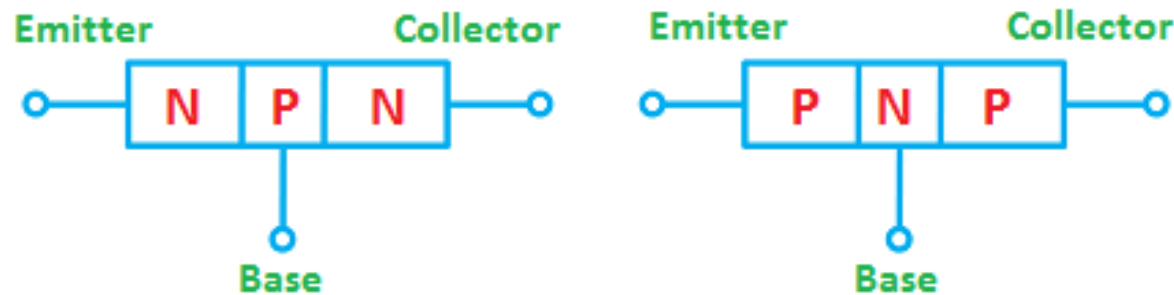


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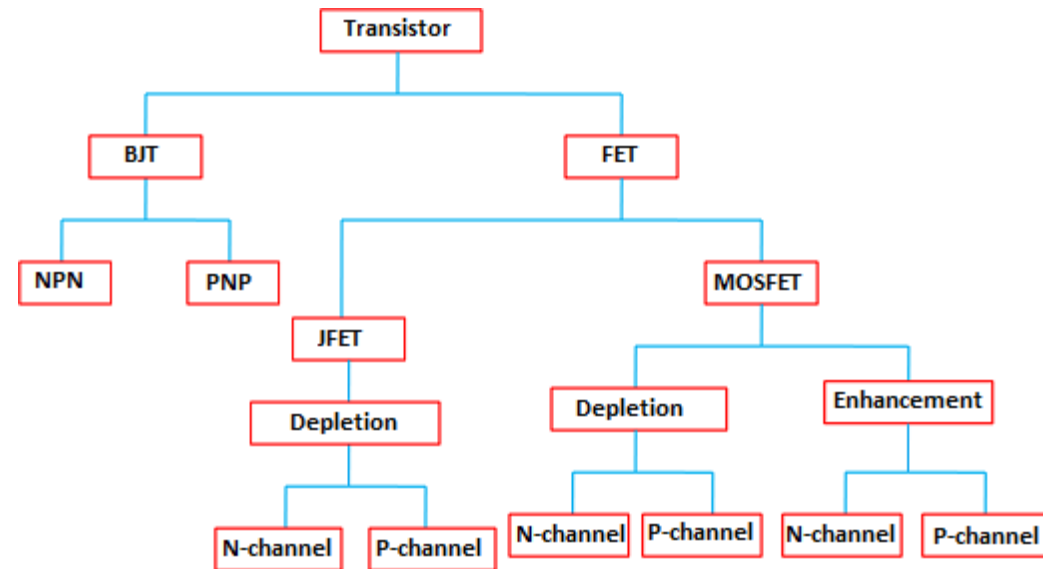
Semiconductor transistor construction and operation

- Transistors are the **basic component of the contemporary industry**
 - Computers, electronic devices, power electronics, etc.
 - Before the **discovery of transistors in 1947**, vacuum tubes were used to build amplifiers
- Transistors are semiconductor **device with 3 terminals**
 - They are used to **switch or control the current flow**
 - The **basic construction and operation of a transistor is similar to that of a diode**
 - Instead of a single junction, **transistors have double junction: p-n-p or n-p-n**



Semiconductor transistor construction and operation

- Transistors are classified according to their **mode of operation**
 - Bipolar Junction Transistor (BJT) : **both electrons and holes** ensure conduction
 - Field Effect Transistor (FET): **either electrons or holes** ensure conduction.
 - JFET = Junction Field Effect Transistor
 - MOSFET = Metal Oxide Semiconductor Field Effect Transistor.



Classification of transistors

Semiconductor transistor construction and operation

- Operation of transistor is controlled by controlling the dc input voltages:

- **Cut-off mode:**

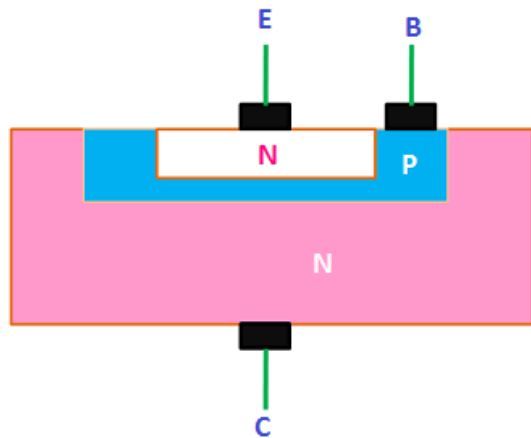
- $V_{BE} > 0, V_{BC} > 0 \rightarrow$ both junction blocking \rightarrow switch OFF

- **Saturation mode:**

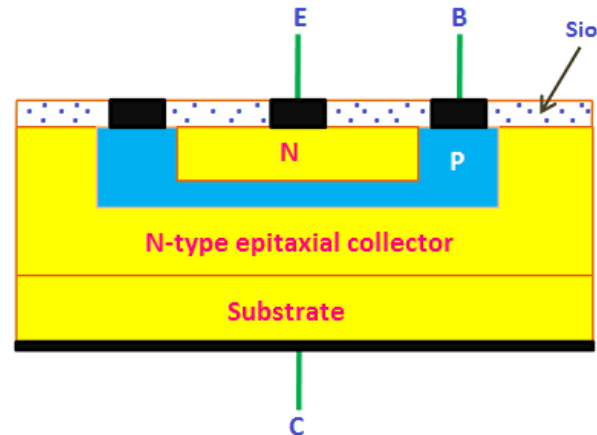
- $V_{BE} < 0, V_{BC} < 0 \rightarrow$ both junctions conducting \rightarrow switch ON

- **Active mode:**

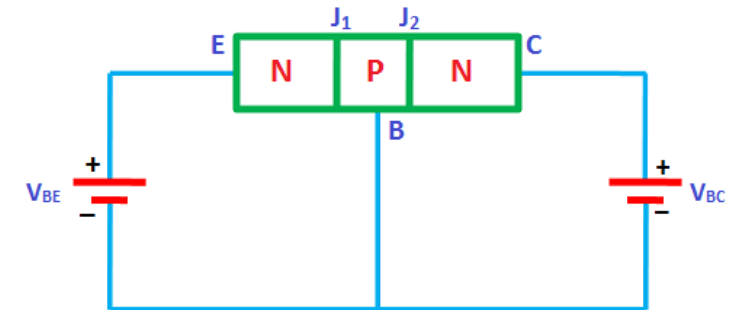
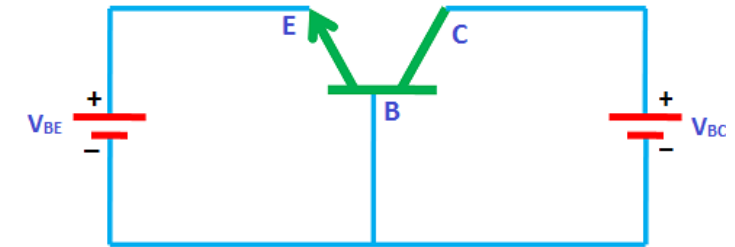
- $V_{BE} < 0, V_{BC} > 0 \rightarrow$ EB in conduction and CB in blocking mode
 - small E-C current causes large C-B current \rightarrow amplifier



Diffusion junction transistor



Epitaxial junction transistor



Cutoff mode

Photovoltaic panels-operation

- Photons with energy higher than band gap rise electrons from valence band to conduction band. A hole is left in the valence band
- Electric field in depletion layer drives electrons to n-type and holes to p-type
 - Electric current flows, but some electrons and holes might recombine

